

# Silicon Bridge Rectifier

**V<sub>RRM</sub> = 50 V - 1000 V**  
**I<sub>F</sub> = 6 A**

## Features

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Types up to 1000 V V<sub>RRM</sub>
- Ideal for printed circuit board
- High surge overload rating
- High temperature soldering guaranteed: 260°C/ 10 seconds, 0.375(9.5mm) lead length
- Glass passivated chip junction
- High case dielectric strength 1500 V<sub>RMS</sub>

**GBU Package**



## Mechanical Data

Case: Molded plastic body over passivated junctions

Mounting position: Any

Terminals: Plated leads, solderable per MIL-STD-750

Method 2026 guaranteed

## Maximum ratings, at T<sub>j</sub> = 25 °C, unless otherwise specified

Parameter	Symbol	Conditions	GBU6A	GBU6B	GBU6D	GBU6G	Unit
Repetitive peak reverse voltage	V <sub>RRM</sub>		50	100	200	400	V
RMS reverse voltage	V <sub>RMS</sub>		35	70	140	280	V
DC blocking voltage	V <sub>DC</sub>		50	100	200	400	V
Continuous forward current	I <sub>F</sub>	T <sub>C</sub> ≤ 100 °C	6	6	6	6	A
Surge non-repetitive forward current, Half Sine Wave	I <sub>F,SM</sub>	T <sub>C</sub> = 25 °C, t <sub>p</sub> = 8.3 ms	175	175	175	175	A
Operating temperature	T <sub>j</sub>		-55 to 150	-55 to 150	-55 to 150	-55 to 150	°C
Storage temperature	T <sub>stg</sub>		-55 to 150	-55 to 150	-55 to 150	-55 to 150	°C

## Electrical characteristics, at T<sub>j</sub> = 25 °C, unless otherwise specified

Parameter	Symbol	Conditions	GBU6A	GBU6B	GBU6D	GBU6G	Unit
Diode forward voltage	V <sub>F</sub>	I <sub>F</sub> = 6 A, T <sub>j</sub> = 25 °C	1.1	1.1	1.1	1.1	V
Reverse current	I <sub>R</sub>	V <sub>R</sub> = 50 V, T <sub>j</sub> = 25 °C	5	5	5	5	μA

## Thermal characteristics

Thermal resistance, junction - case	R <sub>thJA</sub>		7.4	7.4	7.4	7.4	°C/W
	R <sub>thJL</sub>		2.2	2.2	2.2	2.2	

